L Number	Hits	Search Text	DB	Time stamp
- Number	312947	circuit near board	USPAT;	2004/04/02
	312347	Circuit hear board	US-PGPUB;	14:15
			EPO; JPO;	
			DERWENT;	
<u> </u>	472149	epoxy or polyimide	IBM_TDB USPAT;	2004/04/02
	4/2145	epoxy of polymitte	US-PGPUB;	14:15
			EPO; JPO;	11110
			DERWENT;	
	53447	metal near foil	IBM_TDB	2004/04/02
] -	33447	Metal Meal 1011	USPAT; US-PGPUB;	2004/04/02 14:15
			EPO; JPO;	11.15
			DERWENT;	
	56	( singular many house) by a fig. (	IBM_TDB	0004/04/00
-	36	(circuit near board) near5 (epoxy or polyimide) near5 (metal near foil)	USPAT; US-PGPUB;	2004/04/02 14:25
		polyimide, hears (metal hear roll)	EPO; JPO;	14.23
			DERWENT;	
			IBM_TDB	
-	1338	prepreg near3 circuit	USPAT; US-PGPUB;	2004/04/02
			EPO; JPO;	14:26
	] .		DERWENT;	
			IBM_TDB	
-	216	'L	USPAT;	2004/04/02
		polyimide)	US-PGPUB; EPO; JPO;	14:26
			DERWENT;	
			IBM TDB	
-	4		USPAT;	2004/04/02
		polyimide)) same (metal near foil)	US-PGPUB; EPO; JPO;	14:27
			DERWENT;	
1			IBM TDB	
-	759	(coat or coating) near3 prepreg	USPAT;	2004/04/02
			US-PGPUB; EPO; JPO;	14:31
			DERWENT;	
			IBM TDB	]
-	208	(epoxy or polyimide) same ((coat or	USPAT;	2004/04/02
1		coating) near3 prepreg)	US-PGPUB;	14:27
1			EPO; JPO; DERWENT;	
			IBM TDB	
-	31	(metal near foil) and ((epoxy or	USPAT;	2004/04/02
		<pre>polyimide) same ((coat or coating) near3 prepreg))</pre>	US-PGPUB;	14:27
		   brchred!	EPO; JPO; DERWENT;	
			IBM_TDB	]
-	140	(coat or coating) near10 prepreg near10	USPAT;	2004/04/02
		circuit	US-PGPUB;	14:56
			EPO; JPO; DERWENT;	
			IBM TDB	
-	2	("5837355").PN.	USPAT;	2004/04/02
			US-PGPUB;	14:52
[		•	EPO; JPO; DERWENT;	
			IBM TDB	
-	16	("3558423"   "3660199"   "4020225"	USPAT	2004/04/02
		"4579772"   "4623578"   "4714648"		14:52
		"4751146"   "4798762"   "4975319"   "4994133"   "5273816"   "5368921"		
		"5599612"   "5644003"   "5670250"		
		"5677045").PN.		
-	1 ]	5837355.URPN.	USPAT	2004/04/02
<u> </u>	Li		<u> </u>	14:55

_	197	(coat or coating) near5 (circuit near	USPAT;	2004/04/02
		board) near5 (epoxy or polyimide)	US-PGPUB;	14:59
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
i -	1	"62230090"	USPAT;	2004/04/02
			US-PGPUB;	14:58
İ			EPO; JPO;	14.50
	· ·		DERWENT;	
	21	(most	IBM_TDB	0004/04/00
-	21	(coat or coating) near5 ((interlayer or	USPAT;	2004/04/02
		(inner near layer)) near2 (circuit near	US-PGPUB;	15:01
İ		board))	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	13	"2911778"	USPAT;	2004/04/02
			US-PGPUB;	15:01
			EPO; JPO;	
			DERWENT;	
1			IBM TDB	1
-	3	"08111585"	USPĀT;	2004/04/02
1	1		US-PGPUB;	15:01
1	1		EPO; JPO;	13.01
1			DERWENT;	
		·	1	
<b> </b> _'	2	("5756190").PN.	IBM_TDB	2024/24/25
-		( 3/36190 ).PM.	USPAT;	2004/04/05
			US-PGPUB;	10:13
			EPO; JPO;	
	ļ		DERWENT;	
1			IBM_TDB	
-	10	("4311753"   "4372800"   "4410612"	USPAT	2004/04/05
		"4477512"   "4578315"   "5075155"		07:59
•		"5160783"   "5234970"   "5346743"		
		"5412002").PN.		
_	2	("5976699").PN.	USPAT;	2004/04/05
			US-PGPUB;	08:02
1			EPO; JPO;	*****
			DERWENT;	
			IBM TDB	
_	8	("3395118"   "3873637"   "3888942"	USPAT	2004/04/05
		"4186036"   "4532308"   "4769399"	OSEKI	08:02
		"5278259"   "5302666").PN.		00:02
l _	1	5976699.URPN.	HGDAG	2004/04/05
]	1	JULIOUS OKEN.	USPAT	2004/04/05
	17	ETECTOO UDDN		08:03
_	17	5756190.URPN.	USPAT	2004/04/05
	_	H071 60 40 H		08:03
_	3	"9716948"	USPAT;	2004/04/05
			US-PGPUB;	08:04
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
-	2	("5806177").PN.	USPAT;	2004/04/05
			US-PGPUB;	08:15
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
_	3	("4528064"   "4687528"   "5592737").PN.	USPAT	2004/04/05
		( 2020001   2007020   3092737   PW.	OSFAI	2004/04/05
_	16	5806177.URPN.	HCDAE	08:16
	10	JOUGI//.UKPN.	USPAT	2004/04/05
L	L			08:16